

bq24190/2/2i/3/6 and bq24292i EVM (PWR021) User's Guide

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1 Introduction

1.1 EVM Features

Refer to the respective data sheet (shown in [Table 1](#)) for detailed features and operation.

Table 1. Device Data Sheet

Device Name	Literature Number
bq24190/2/2i/3	SLUSAW5B
bq24196	SLUSB98
bq24292i	SLUSBI4

The bq24x9x evaluation module (EVM) is a complete charger module for evaluating an I²C-controlled single NVDC-1 charge using the bq24x9x devices.

This EVM does not include the USB-to-GPIO interface board. To evaluate the bq24x9x EVM, a USB-to-GPIO interface board must be ordered separately.

1.2 I/O Descriptions

[Table 2](#) lists the jumper connections available on this EVM.

Table 2. EVM Connections

Jack	Description
J1 – PMID	PMID pin connection/Power bank output
J1 – VBUS	Input: positive terminal
J1 – GND	Input: negative terminal (ground terminal)
J2 – SYS	Connected to system
J2 – BAT+	Connected to battery pack
J2 – GND	Ground
J3	USB-to-GPIO connector (USB Interface Adapter Connector - HPA172)
J4 – INT	INT pin connection
J4 – OTG	OTG pin connection
J4- $\overline{CE}$	$\overline{CE}$ pin connection
J4-GND	Ground
J5-TS2	External TS2 pin connection
J5-GND	Ground
J6-TS1	External TS1 pin connection
J6-GND	Ground
J7	Mini_USB Connector

Table 3 lists the controls and key parameter settings for this EVM.

Table 3. Jumper Connections

Jack	Description	Factory Setting
JP1	For bq24190/2/2i/3/6 and bq24292i input current setting: PSEL LOW: Adaptor input PSEL HIGH: USB input	bq24190: Not installed bq24192/2i/3/6 and bq24292i : Short PSEL to LOW
JP2	D-/PG pin selection	Bq24190: Short D-/PG to D- bq24192/2i/3/6 and bq24292i : Short D-/PG to PG
JP3	STAT, PG, /CE, INT, OTG pin internal pull-up source (VSY) jumper	Installed
JP4	USB current limit selection pin during buck mode and PSEL is high (JP1-High)/Enable pin during boost mode. In buck mode: OTG = High, IIN limit = 500 mA; OTG = Low, IIN limit = 100 mA. The boost mode is activated when the REG01[5:4] = 10 and OTG pin is HIGH.	Not installed
JP5	$\overline{\text{CE}}$ pin setting: pull low to enable the charge	Not Installed (GUI also can pull /CE low)
JP6	For bq24190 input current limit setting:	bq24190: installed bq24192/2i/3/6 and bq24292i : Not installed
JP7	TS1 resistor divider pull-up source (REGN) connection	Installed
JP8	internal 10k to ground to TS1	Installed
JP9	internal 10k to ground to TS2	Installed
JP10	TS2 pin setting:	bq24193: Short TS2 and TS1 bq24190/2/2i/6 and bq24292i: Short TS2 and TS2-I

Table 4 lists the recommended operating conditions for this EVM.

Table 4. Recommended Operating Conditions

Symbol	Description	MIN	TYP	MAX	Unit
Supply voltage, V_{IN}	Input voltage from AC adapter	3.9	5/12	17	VDC
Battery voltage, V_{BAT}	Voltage applied at V_{BAT} terminal	0	3.7	4.25	VDC
Supply current, I_{AC}	Maximum input current from AC adapter input	0		3	A
Output current, I_{OUT}	Output current	0		4	A
Operating junction temperature range, T_{J}		0		125	°C

2 Test Summary

[Section 2.1](#) – [Section 2.3](#) explains the equipment, the equipment setup, and the test procedures.

2.1 Equipment

2.1.1 Power Supplies

Power supply #1 (PS#1): a power supply capable of supplying 5 V at 1 A is required. While this part can handle larger voltage and current, it is not necessary for this procedure.

2.1.2 Load #1 (4-Quadrant Supply, Constant Voltage < 4.5 V)

A 0–20 V/0–5 A, > 30-W system, DC electronic load and setting as constant voltage load mode.

Or:

Kepeco load: BOP 20–5M, DC 0 to ± 20 V, 0 to ± 5 A (or higher)

Or:

Real single-cell battery

2.1.3 Load#2 – Use with Boost Mode

PMID to GND load, 10 Ω , 5 W or greater

2.1.4 Meters

Six Fluke 75 multimeters, (equivalent or better)

Or:

Four equivalent voltage meters and two equivalent current meters.

The current meters must be capable of measuring 5 A+ current.

2.1.5 Computer

A computer with at least one USB port and a USB cable. The bq2419xEVM evaluation software must be properly installed.

2.1.6 USB-to-GPIO Communication Kit (HPA172-USB Interface Adapter)

2.1.7 Software

Unzip the bq2419xEVM_GUI.zip and double-click on the *SETUP.EXE* file. Follow the installation steps. The software supports the Windows® XP and Windows 7 operating systems.

2.2 Equipment Setup

1. Set PS#1 for 5-V DC, 1-A current limit and then turn off the supply.
2. Connect the output of PS#1 in series with a current meter (multimeter) to J1 (V_{BUS} and GND).
3. Connect a voltage meter across J1 (V_{BUS}) and J1 (GND).
4. Turn on the Load, set to constant voltage mode and output to 2.5 V. Turn off (disable) Load. Connect Load in series with a current meter (multimeter), ground side, to J2 (BAT+ and GND) as shown in Figure 2.
5. Connect a voltage meter across J2 (BAT+ and GND).
6. Connect the HPA172 USB interface adapter to the computer with a USB mini-cable and to J3 with the 10-pin ribbon cable. The connections are shown in Figure 1.

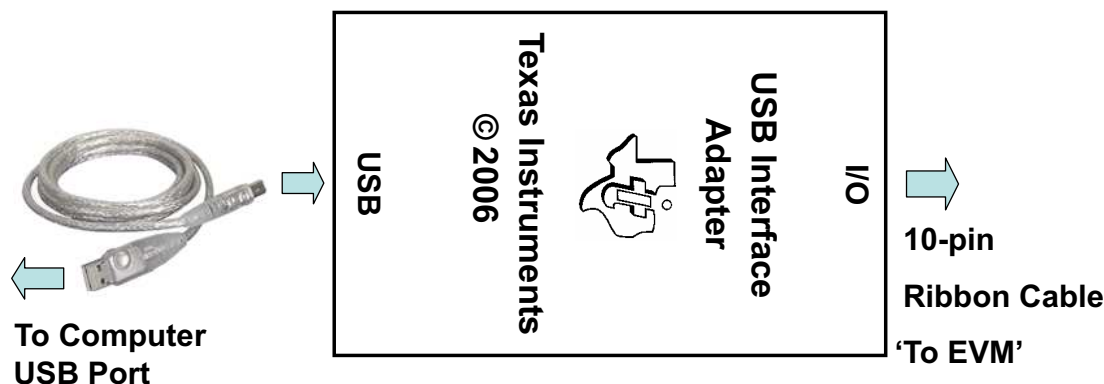


Figure 1. Connections of the HPA172 Kit

7. Install shunts as shown in Table 3.

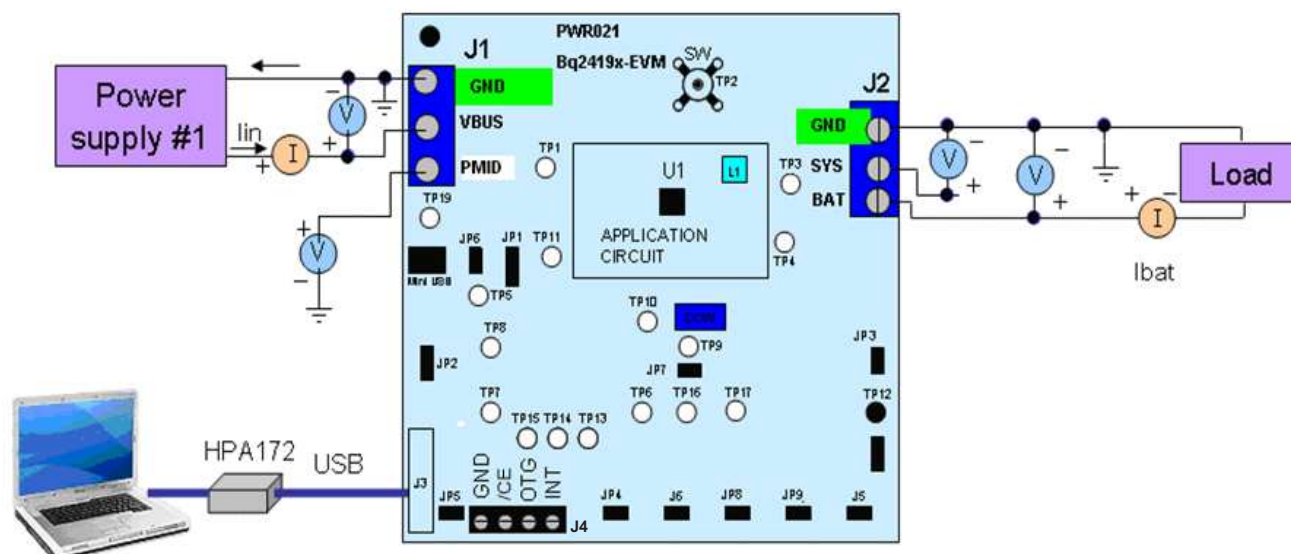


Figure 2. Original Test Setup for PWR021 (bq24x9xEVM)

8. Turn on the computer. Launch the bq2419x evaluation software. The main window of the software is shown in Figure 3.

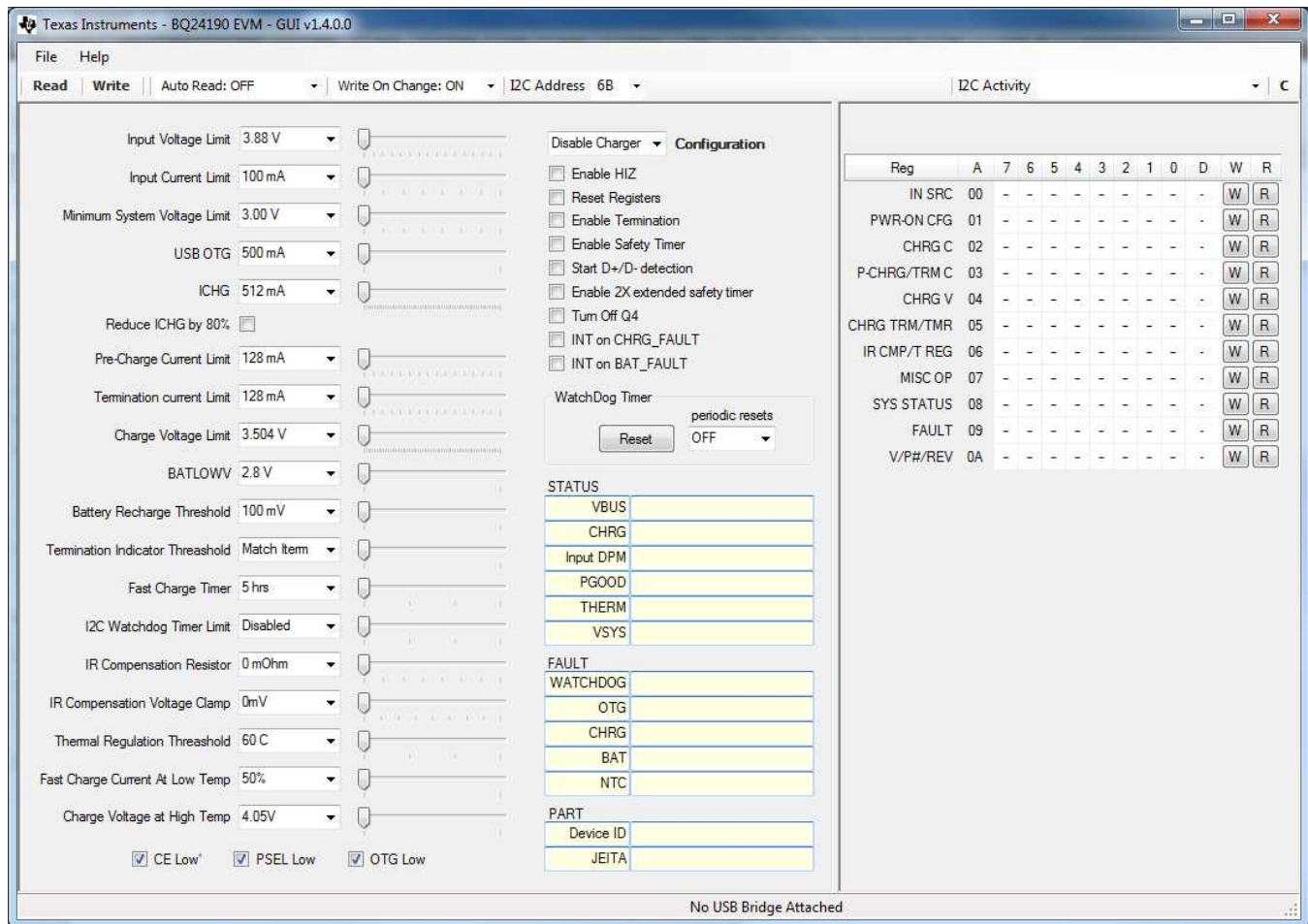


Figure 3. Main Window of the bq2419x Evaluation Software

2.3 Procedure

2.3.1 Current Settings

1. Make Sure EQUIPMENT SETUP steps are followed.
ILIM Setting: Set the potentiometer to its lowest value for max input current by connecting an ohm-meter between point TP9 and ground. Turn the screw on the potentiometer counterclockwise until the resistance drops to its lowest point (this should be in the range of 125 Ω to 175 Ω , the value of R7)
2. Launch the BQ2419x EVM GUI software, if not already done
3. Turn on PS#1
Measure $\rightarrow V(J2(SYS), J2(GND)) = 4.10 \pm 300 \text{ mV}$

2.3.2 Charge Voltage and Current Regulation of V_{IN} and Device ID Verification

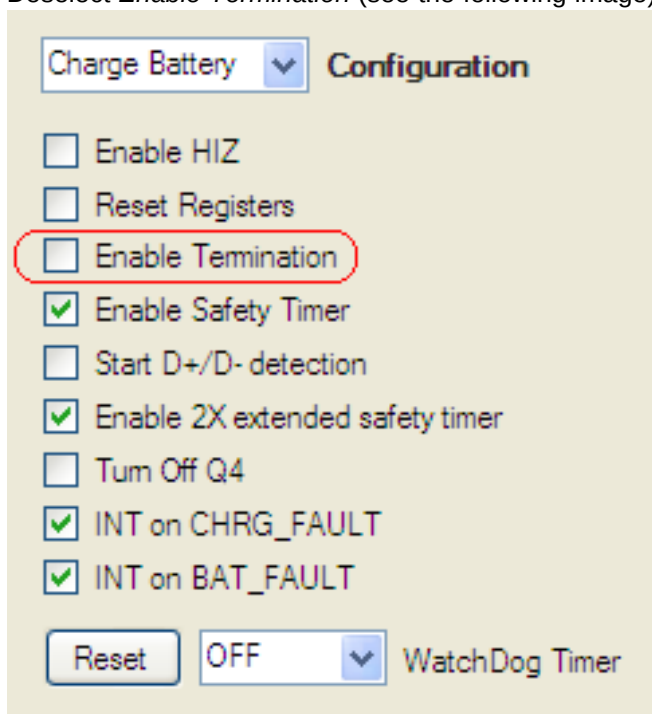
Follow the steps and verify the outputs and IC for the EVM.

2.3.2.1 Software setup (all of Section 2.3.2.1 is done in the GUI):

1. Device address: bq24190/192/192i/193/196 (6B) and bq24292i



2. Click the **Read** button
3. Select *Disabled for I²C Watchdog Timer Limit*
4. Set *Input Voltage Limit* to 4.2 V
5. Set *Input Current Limit* to 500 mA
6. Set *Charge Voltage Limit* to 4.208 V
7. Set *Fast Charge Current, ICHG* to 512 mA
8. Set *Pre-Charge Current* to 256 mA
9. Deselect *Enable Termination* (see the following image)



10. Click the **Read** button twice
 Observe → Everything normal at *FAULT* box
 Observe → D1 (STAT) is on, except the bq24192i/292iEVM
 Observe → D2 (/PG) is on for bq24190/192/192i/193/196/292iEVM

2.3.2.2 Enable Load#1 from Section 2.2 step 4. Measure the voltage across J2 at two different points:

Measure → $V(J2(SYS), J2(GND)) = 3.65 \text{ V} \pm 300 \text{ mV}$

Measure → $V(J2(BAT), J2(GND)) = 2.5 \text{ V} \pm 200 \text{ mV}$

2.3.2.3 Increase the Constant Voltage Load to 3.7 V_{DC}

Measure → V(J2(SYS), J2(GND)) = 3.75 V ±200 mV

Measure → IBAT = 500 mA ±200 mA

Measure → V(J2(BAT), J2(GND)) = 3.7 V ±200 mV

2.3.2.4 In the software, set Fast Charge Current, ICHG to 1.012 A

Measure → I_{in} = 500 mA ±200 mA

2.3.2.5 Verify Scope Measurements (See Figure 4 – 500 ns/div)

C1 (AC coupled 20 mV/div): V_{ac}_PMID (TP20 to GND) – Ripple excluding high frequency spikes < 10 mV

C2 (5 V/div): V_{dc}_SW (TP2) - Frequency between 1.25 MHz and 1.5 MHz, duty cycle between 73% and 81%

C3 (AC coupled 20 mV/div): V_{ac}_V_{sys} (TP3 to GND) - excluding high frequency spikes < 15 mV

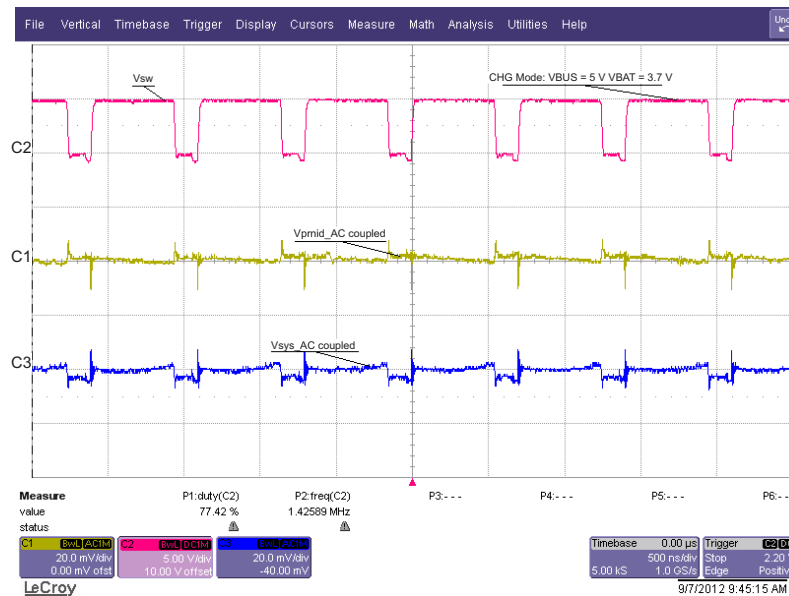


Figure 4. CHG Mode Ripple and Duty Cycle: V_{BUS} = 5 V, V_{BAT} = 3.7 V

2.3.2.6 Switch to Boost Mode

1. Turn off and disconnect PS#1
2. If the constant voltage load connected from BAT+ to GND is not a four-quadrant supply (sources current) remove the load and use the power source disconnected in step one, set to 3.7 V and 2 A current limit and connect between BAT+ and GND
3. Apply 10 Ω (5 W or greater) across J5 (PMID(+)) to GND(–)
4. Uncheck the *OTG Low* box in the GUI
5. Select OTG in the *Configuration* drop-down window
6. Verify V_{PMID} to GND on J5 is between 4.9 V and 5.3 V
7. Verify scope measurement (See Figure 6)
 C1 (AC coupled 20 mV/div): V_{AC_PMID} (TP20 to GND) – Ripple excluding high frequency spikes
 C2 (5 V/div): V_{dc_SW} (TP2) - Frequency between 1.2 MHz and 1.7 MHz, Duty cycle between 67% and 74%

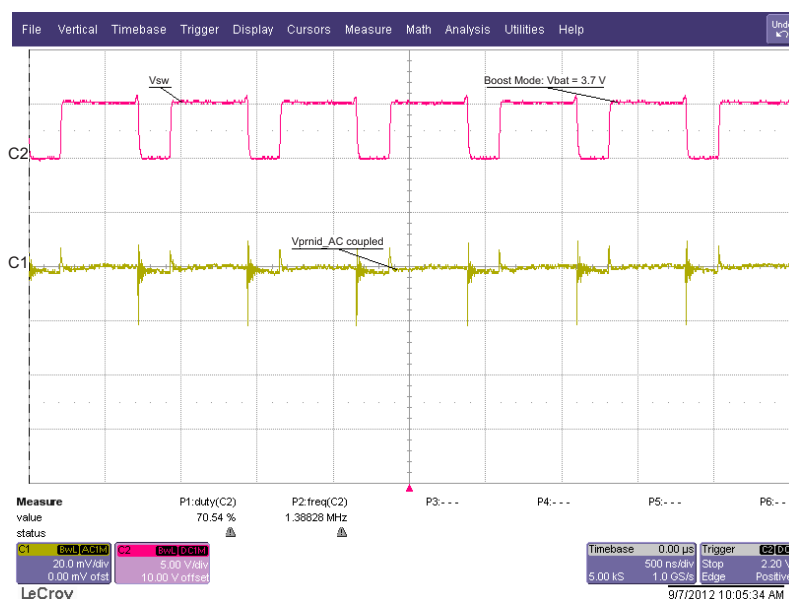


Figure 5. Boost Mode Ripple and Duty Cycle; $V_{BAT} = 3.7\text{ V}$

2.3.2.7 Verify Device ID JEITA shown in software matches Table 5

Table 5. Device ID JEITA Settings

Assembly Number	EVM Part Number	Device ID	JEITA
PWR021-001	bq24190EVM-021	100	Disabled
PWR021-003	bq24192EVM-021	101	Disabled
PWR021-004	bq24192iEVM-021	011	Disabled
PWR021-005	bq24193EVM-021	101	Enabled
PWR021-006	bq24196EVM-021	101	Disabled
PWR021-007	bq24292iEVM-021	011	Disabled

3 PCB Layout Guideline

Minimize the switching node rise and fall times for minimum switching loss. Proper layout of the components minimizing high-frequency current path loop is important to prevent electrical and magnetic field radiation and high frequency resonant problems. This PCB layout priority list must be followed in the order presented for proper layout:

1. Place the input capacitor as close as possible to the PMID and GND pin connections and use the shortest possible copper trace connection or GND plane.
2. Place the inductor input terminal as close to the SW pin as possible. Minimize the copper area of this trace to lower electrical and magnetic field radiation but make the trace wide enough to carry the charging current. Do not use multiple layers in parallel for this connection. Minimize parasitic capacitance from this area to any other trace or plane.
3. Put an output capacitor near to the inductor and the IC. Tie ground connections to the IC ground with a short copper trace connection or GND plane.
4. Route analog ground separately from power ground. Connect analog ground and connect power ground separately. Connect analog ground and power ground together using power pad as the single ground connection point or use a 0- Ω resistor to tie analog ground to power ground.
5. Use a single ground connection to tie the charger power ground to the charger analog ground just beneath the IC. Use ground copper pour but avoid power pins to reduce inductive and capacitive noise coupling.
6. Place decoupling capacitors next to the IC pins and make the trace connection as short as possible.
7. It is critical that the exposed power pad on the backside of the IC package be soldered to the PCB ground. Ensure that there are sufficient thermal vias directly under the IC, connecting to the ground plane on the other layers.
8. The via size and number should be enough for a given current path.

See the EVM design for the recommended component placement with trace and via locations. For the QFN information, refer to [SCBA017](#) and [SLUA271](#).

4 Board Layout, Schematic, and Bill of Materials

4.1 Board Layout

Figure 6 through Figure 11 illustrate the board layouts for this EVM.

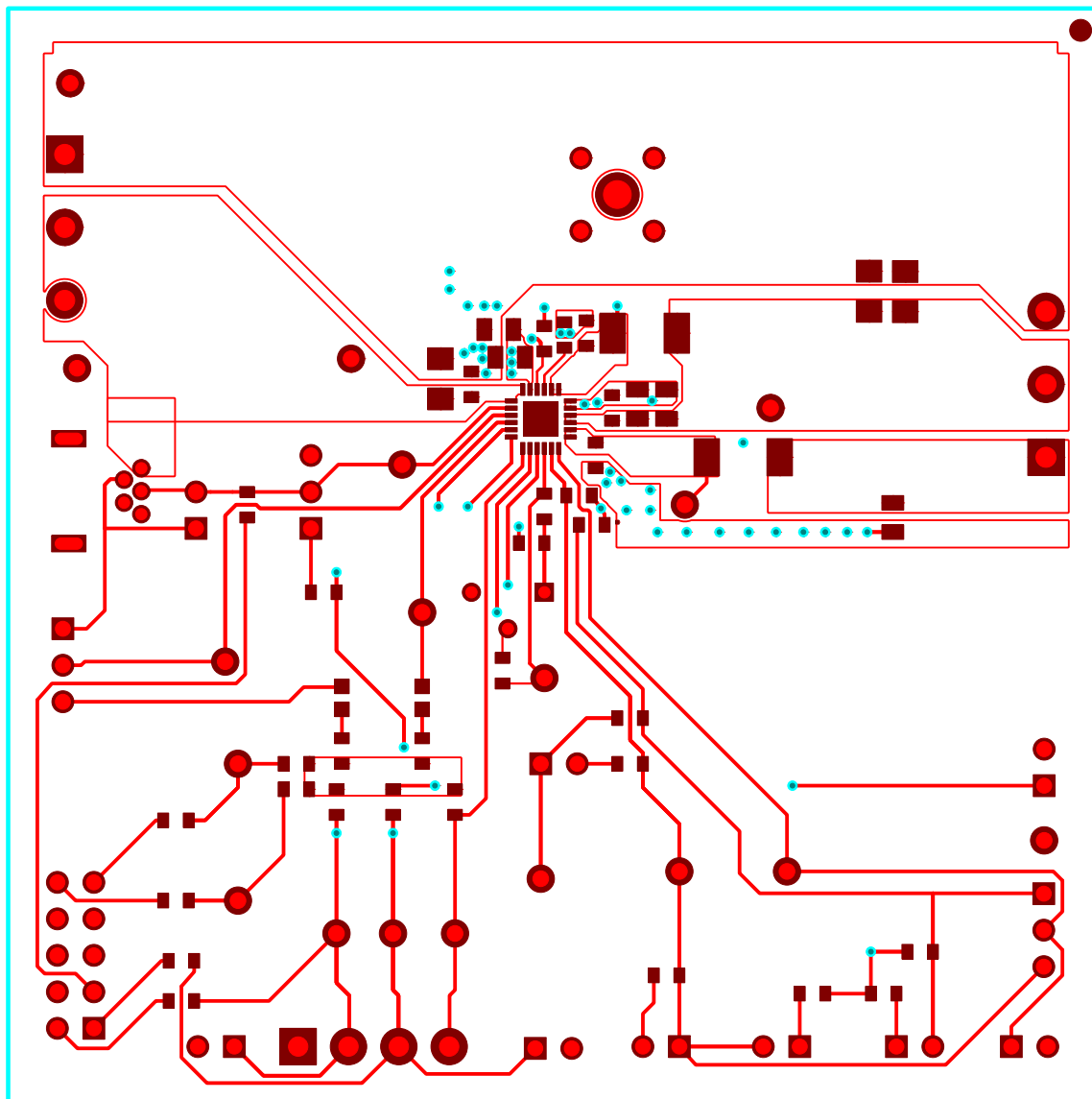


Figure 6. bq24x9xEVM Top Layer

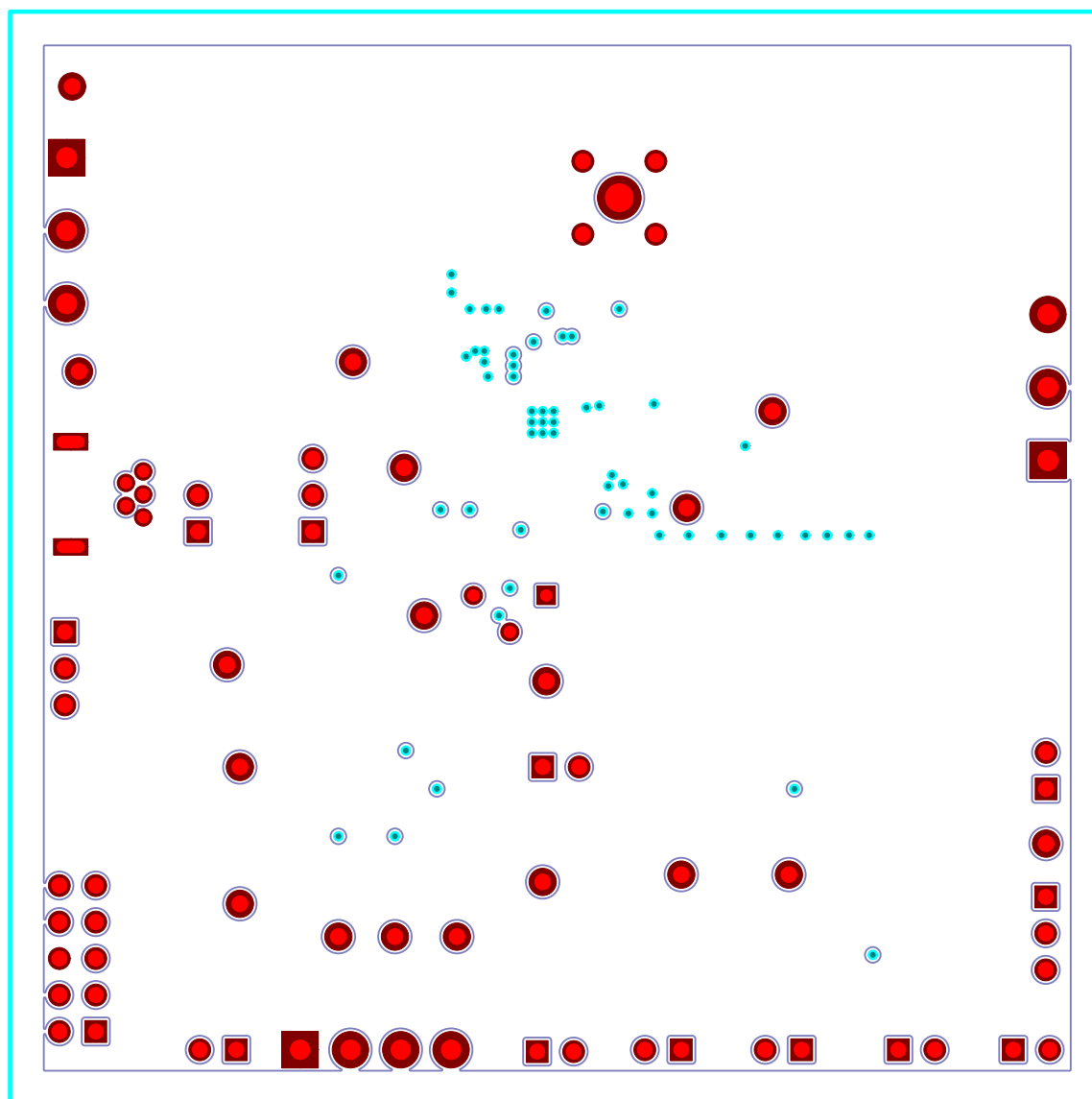


Figure 7. bq24x9xEVM Second Layer

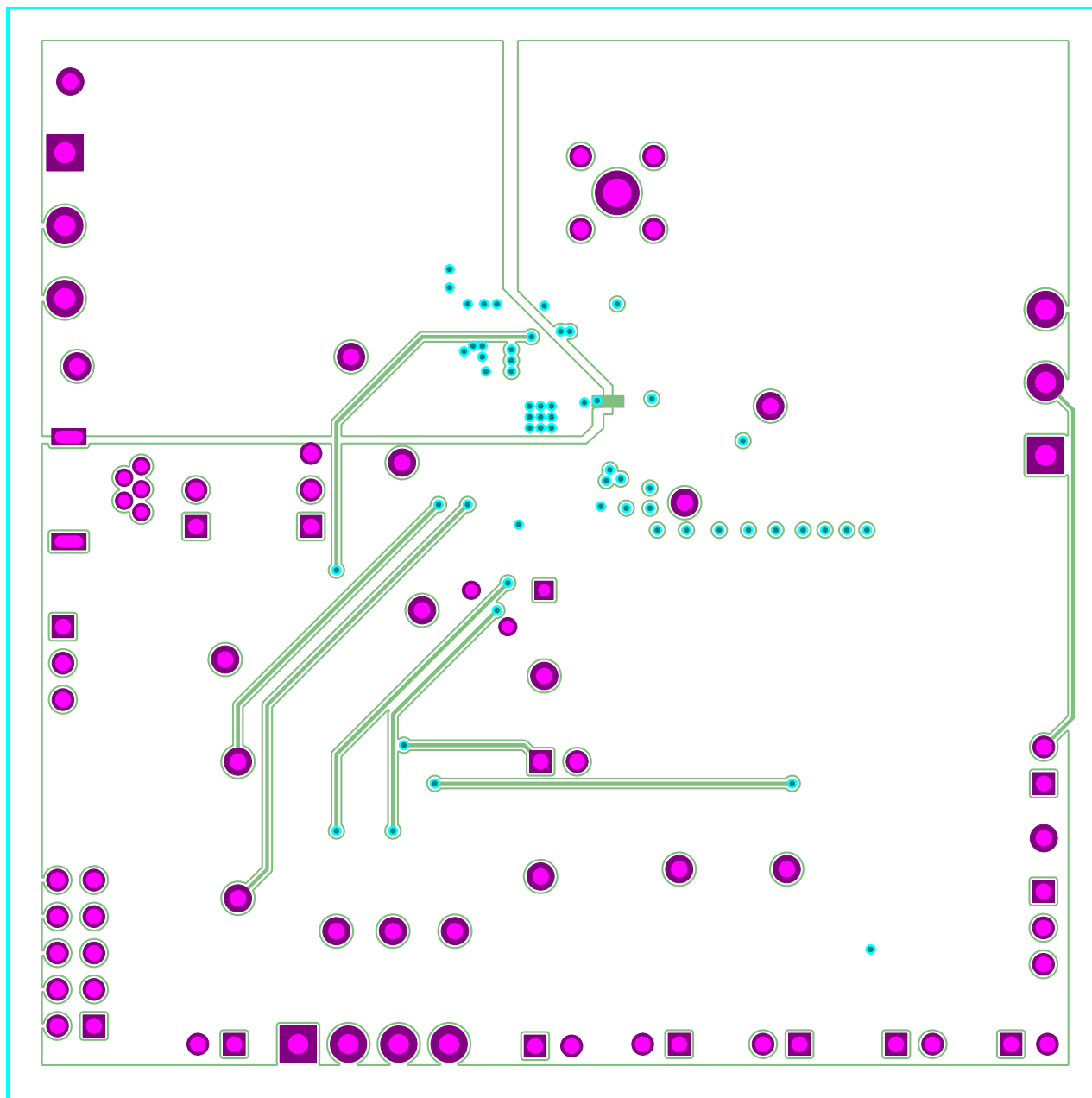


Figure 8. bq24x9xEVM Third Layer

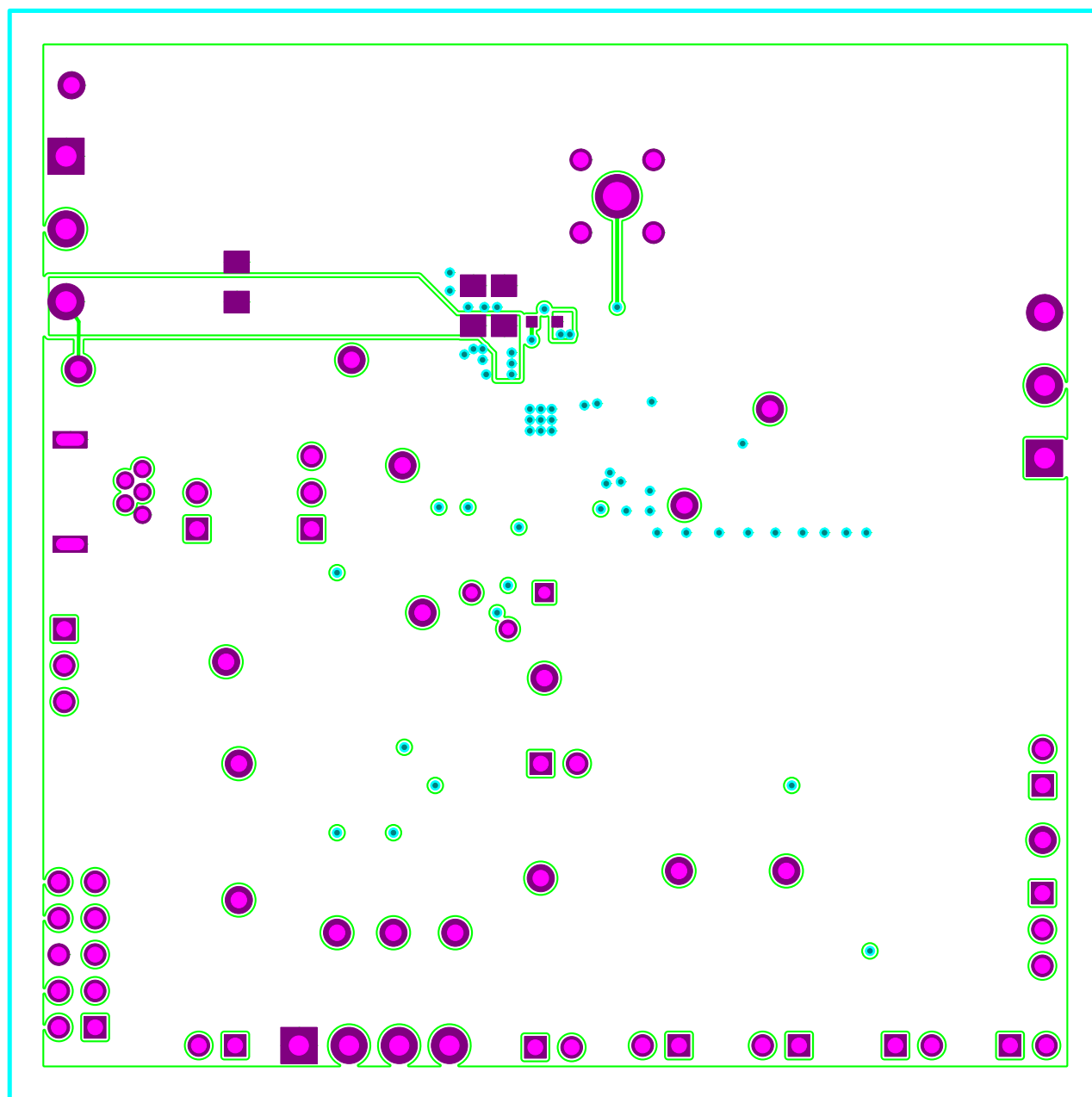


Figure 9. bq24x9xEVM Bottom Layer

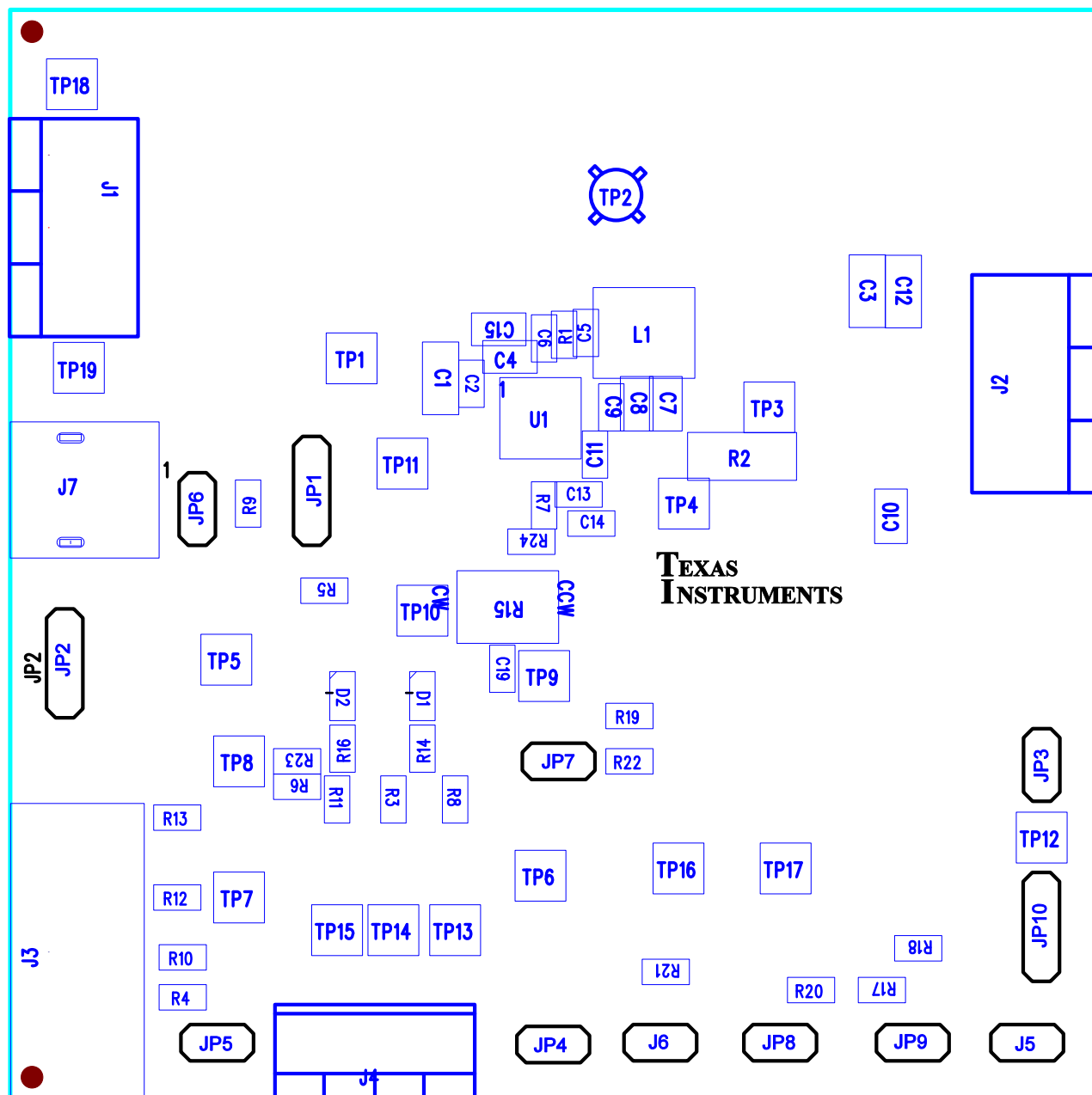


Figure 10. bq24x9xEVM Top Assembly

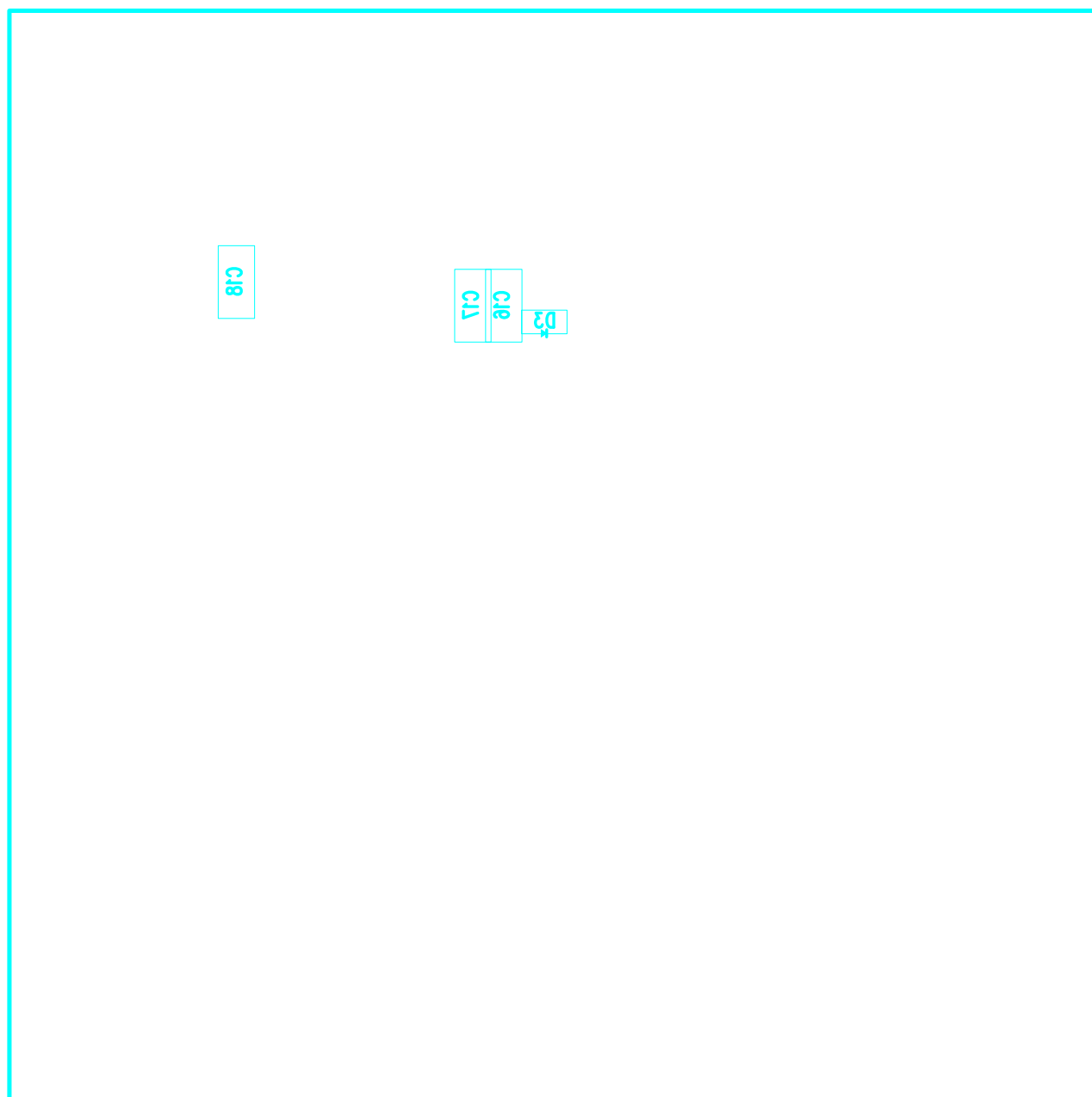


Figure 11. bq24x9xEVM Bottom Assembly

4.2 Schematic

Figure 12 illustrates the schematic for this EVM.

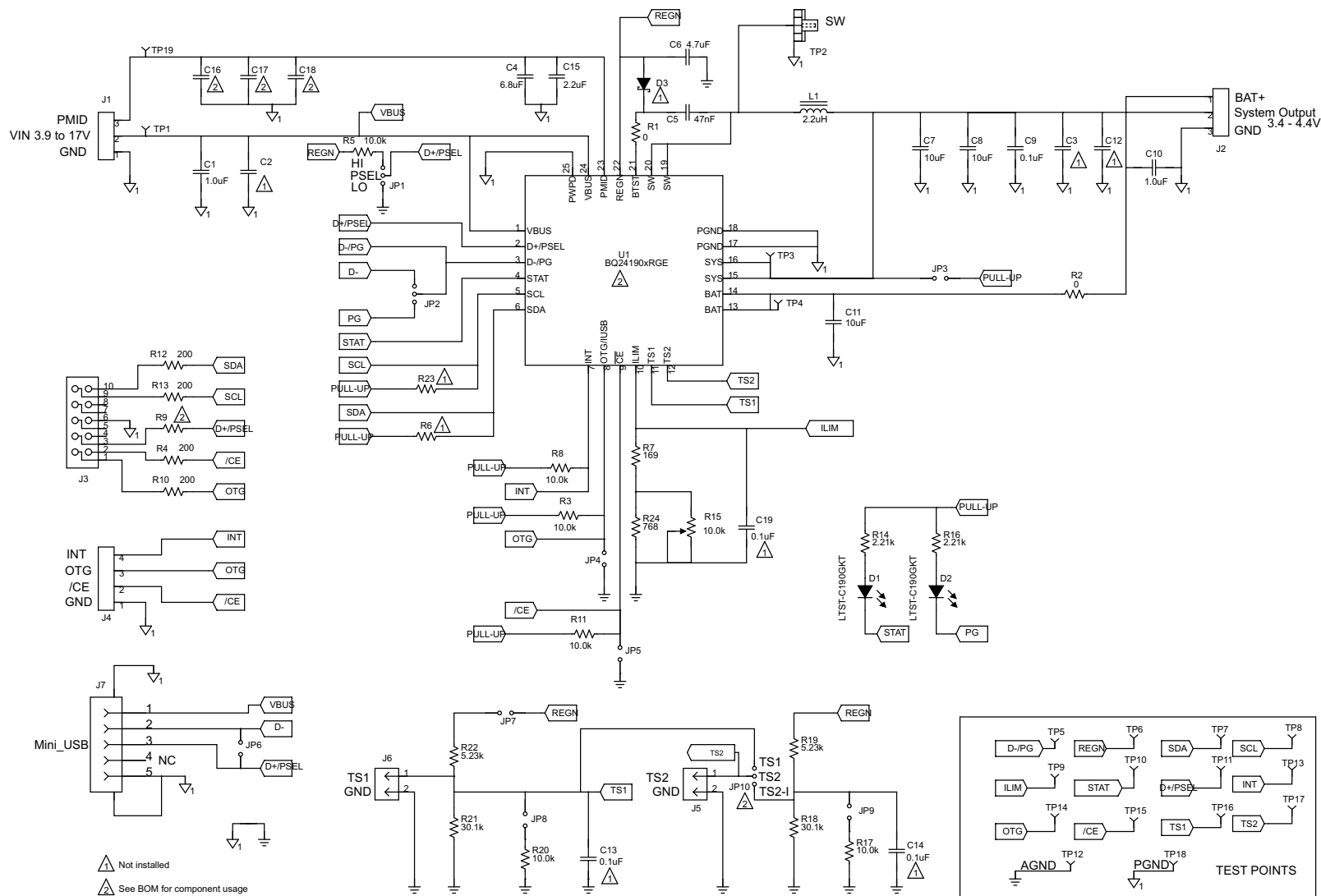


Figure 12. bq24x9xEVM Schematic

4.3 Bill of Materials

Table 6 contains the bill of materials.

Table 6. Bill of Materials

COUNT						RefDes	Value	Description	Size	Part Number	RefDes
-001	-003	-004	-005	-006	-007						
1	1	1	1	1	1	C1	1.0uF	Capacitor, Ceramic, 25V, X7R, 10%	1206	STD	STD
0	0	0	0	0	0	C2	OPEN	Capacitor, Ceramic,	0603	STD	STD
0	0	0	0	0	0	C3, C12	OPEN	Capacitor, Ceramic, 10V, X5R, 10%	1206	STD	STD
1	1	1	1	1	1	C4	6.8uF	Capacitor, Ceramic, 25V, X5R, 10%	0805	STD	STD
1	1	1	1	1	1	C5	47nF	Capacitor, Ceramic, 16V, X7R, 10%	0603	STD	STD
1	1	1	1	1	1	C6	4.7uF	Capacitor, Ceramic, 10V, X5R, 10%	0603	STD	STD
2	2	2	2	2	2	C7, C8	10uF	Capacitor, Ceramic, 10V X5R, 10%	0805	STD	STD
1	1	1	1	1	1	C9	0.1uF	Capacitor, Ceramic, 25V, X7R, 10%	0603	STD	STD
0	0	0	0	0	0	C13-14, C19	0.1uF	Capacitor, Ceramic, 25V, X7R, 10%	0603	STD	STD
1	1	1	1	1	1	C10	1.0uF	Capacitor, Ceramic, 10V, X7R, 10%	0805	STD	STD
1	1	1	1	1	1	C11	10uF	Capacitor, Ceramic, 10V, X5R, 10%	0603	STD	STD
1	1	1	1	1	1	C15	2.2uF	Capacitor, Ceramic, 25V, X5R, 10%	0805	STD	STD
0	0	0	0	0	0	C16, C17, C18	47uF	Capacitor, Ceramic, 10V, X5R, 20%	1206	STD	STD
2	2	2	2	2	2	D1, D2	LTST-C190GKT	Diode, LED, Green, 2.1-V, 20-mA, 6-mcd	0603	LTST-C190GKT	Lite On
0	0	0	0	0	0	D3	ZLLS350	Diode, Schottky, 1.16A, 40-V	SOD-523	ZLLS350TA	Zetex
2	2	2	2	2	2	J1,2	ED120/3DS	Terminal Block, 3-pin, 15-A, 5.1mm	0.60 x 0.35 inch	ED120/3DS	OST
1	1	1	1	1	1	J3	N2510-6002RB	Connector, Male Straight 2x5 pin, 100mil spacing, 4 Wall	0.338 x 0.788 inch	N2510-6002RB	3M
1	1	1	1	1	1	J4	ED555/4DS	Terminal Block, 4-pin, 6-A, 3.5mm	0.55 x 0.25 inch	ED555/4DS	OST
2	2	2	2	2	2	J5-6	PEC02SAAN	Header, Male 2-pin, 100mil spacing,	0.100 inch x 2	PEC02SAAN	Sullins
1	1	1	1	1	1	J7	56579-0519	Connector, USB-B, Mini, 5-pins	0.354 X 0.307 Inches	56579-0519	Molex
3	3	3	3	3	3	JP1-2, JP10	PEC03SAAN	Header, Male 3-pin, 100mil spacing,	0.100 inch x 3	PEC03SAAN	Sullins
7	7	7	7	7	7	JP3-9	PEC02SAAN	Header, Male 2-pin, 100mil spacing,	0.100 inch x 2	PEC02SAAN	Sullins
1	1	1	1	1	1	L1	2.2uH	Inductor, SMT, 4.2A, 45.6-milliohm	0.216 x 0.204 inch	IHLP2020BZER2R2M01	Vishay
1	1	1	1	1	1	R1	0	Resistor, Chip, 1/16W,	0603	STD	STD
1	1	1	1	1	1	R2	0	Resistor, Chip, 0.5W	2010	STD	STD
6	6	6	6	6	6	R3 R5 R8 R11 R17 R20	10.0k	Resistor, Chip, 1/16W, 1%	0603	STD	STD
4	4	4	4	4	4	R4 R10 R12 R13	200	Resistor, Chip, 1/16W, 1%	0603	STD	STD
0	0	0	0	0	0	R6 R23	OPEN	Resistor, Chip, 1/16W,	0603	STD	STD
1	1	1	1	1	1	R7	130	Resistor, Chip, 1/16W, 1%	0603	STD	STD
0	1	1	1	1	1	R9	200	Resistor, Chip, 1/16W, 1%	0603	STD	STD
2	2	2	2	2	2	R14, R16	2.21k	Resistor, Chip, 1/16W, 1%	0603	STD	STD
1	1	1	1	1	1	R15	10.0k	Potentiometer, 3/8 Cermet, Single-Turn	0.25x0.17 inch	3266W-1-103LF	Bourns
0	0	0	1	0	0	R21	6.81k	Resistor, Chip, 1/16W, 1%	0603	STD	STD
0	0	0	1	0	0	R22	2.26k	Resistor, Chip, 1/16W, 1%	0603	STD	STD
1	1	1	0	1	1	R21	30.1k	Resistor, Chip, 1/16W, 1%	0603	STD	STD
1	1	1	0	1	1	R22	5.23k	Resistor, Chip, 1/16W, 1%	0603	STD	STD

Table 6. Bill of Materials (continued)

COUNT						RefDes	Value	Description	Size	Part Number	RefDes
-001	-003	-004	-005	-006	-007						
1	1	1	1	1	1	R18	30.1k	Resistor, Chip, 1/16W, 1%	0603	STD	STD
1	1	1	1	1	1	R19	5.23k	Resistor, Chip, 1/16W, 1%	0603	STD	STD
1	1	1	1	1	1	R24	768	Resistor, Chip, 1/16W, 1%	0603	STD	STD
16	16	16	16	16	16	TP1 TP3-11 TP13-17 TP19	5002	Test Point, White, Thru Hole Color Keyed	0.100 x 0.100 inch	5002	Keystone
1	1	1	1	1	1	TP2	131-4244-00	Adaptor, 3.5-mm probe clip (or 131-5031-00)	0.200 inch	131-4244-00	Tektronix
2	2	2	2	2	2	TP12 TP18	5001	Test Point, Black, Thru Hole Color Keyed	0.100 x 0.100 inch	5001	Keystone
1	0	0	0	0	0	U1	BQ24190RGE	IC, I2C Controlled 4A Single Cell USB / Adaptor Charger With Narrow VDC Power Path Management and USB OTG	QFN-24	BQ24190RGE	TI
0	0	0	0	0	0	U1	BQ24191RGE	IC, I2C Controlled 4A Single Cell USB / Adaptor Charger With Narrow VDC Power Path Management	QFN-24	BQ24191RGE	TI
0	1	0	0	0	0	U1	BQ24192RGE	IC, I2C Controlled 4A Single Cell USB / Adaptor Charger With Narrow VDC Power Path Management and USB OTG	QFN-24	BQ24192RGE	TI
0	0	1	0	0	0	U1	BQ24192IRGE	IC, I2C Controlled 4A Single Cell USB / Adaptor Charger With Narrow VDC Power Path Management and USB OTG	QFN-24	BQ24192IRGE	TI
0	0	0	1	0	0	U1	BQ24193RGE	IC, I2C Controlled 4A Single Cell USB / Adaptor Charger With Narrow VDC Power Path Management and USB OTG	QFN-24	BQ24193RGE	TI
0	0	0	0	1	0	U1	BQ24196RGE	IC, I2C Controlled 2.5A Single Cell USB / Adaptor Charger With Narrow VDC Power Path Management and USB OTG	QFN-24	BQ24196RGE	TI
0	0	0	0	0	1	U1	BQ24292IRGE	IC, I2C Controlled 4A Single Cell USB / Adaptor Charger With Narrow VDC Power Path Management and USB OTG	QFN-25	BQ24292IRGE	TI
10	10	10	10	10	10	--		Shunt, 100-mil, Black	0.100	929950-00	3M
1	1	1	1	1	1	--		PCB, bq2419xEVM-021, 3"x3"		PWR021	Any
1	1	1	1	1	1	--		Label (See note 5)	1.25 x 0.25 inch	THT-13-457-10	Brady
4	4	4	4	4	4	-	SJ-5303	Rubber foot (see note 6)	.044" X 0.20"	SJ-5303	3M
Notes:											
1. These assemblies are ESD sensitive, observe ESD precautions.											
2. These assemblies must be clean and free from flux and all contaminants. Use of no-clean flux is not acceptable.											
3. These assemblies must comply with workmanship standards IPC-A-610 Class 2.											
4. Ref designators marked with an asterisk (***) cannot be substituted. All other components can be substituted with equivalent MFG's components.											
5. Install label after final wash. Text shall be 8 pt font. Text shall be per Label Information .											
6. Install after final wash.											
Label Information											
Assembly number						Text					
PWR021-001						bq24190EVM-021					
PWR021-003						bq24192EVM-021					
PWR021-004						bq24192IEVM-021					
PWR021-005						bq24193EVM-021					
PWR021-006						bq24196EVM-021					
PWR021-007						bq24292IEVM-021					

EVALUATION BOARD/KIT/MODULE (EVM) ADDITIONAL TERMS

Texas Instruments (TI) provides the enclosed Evaluation Board/Kit/Module (EVM) under the following conditions:

The user assumes all responsibility and liability for proper and safe handling of the goods. Further, the user indemnifies TI from all claims arising from the handling or use of the goods.

Should this evaluation board/kit not meet the specifications indicated in the User's Guide, the board/kit may be returned within 30 days from the date of delivery for a full refund. THE FOREGOING LIMITED WARRANTY IS THE EXCLUSIVE WARRANTY MADE BY SELLER TO BUYER AND IS IN LIEU OF ALL OTHER WARRANTIES, EXPRESSED, IMPLIED, OR STATUTORY, INCLUDING ANY WARRANTY OF MERCHANTABILITY OR FITNESS FOR ANY PARTICULAR PURPOSE. EXCEPT TO THE EXTENT OF THE INDEMNITY SET FORTH ABOVE, NEITHER PARTY SHALL BE LIABLE TO THE OTHER FOR ANY INDIRECT, SPECIAL, INCIDENTAL, OR CONSEQUENTIAL DAMAGES.

Please read the User's Guide and, specifically, the Warnings and Restrictions notice in the User's Guide prior to handling the product. This notice contains important safety information about temperatures and voltages. For additional information on TI's environmental and/or safety programs, please visit www.ti.com/esh or contact TI.

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REGULATORY COMPLIANCE INFORMATION

As noted in the EVM User's Guide and/or EVM itself, this EVM and/or accompanying hardware may or may not be subject to the Federal Communications Commission (FCC) and Industry Canada (IC) rules.

For EVMs **not** subject to the above rules, this evaluation board/kit/module is intended for use for ENGINEERING DEVELOPMENT, DEMONSTRATION OR EVALUATION PURPOSES ONLY and is not considered by TI to be a finished end product fit for general consumer use. It generates, uses, and can radiate radio frequency energy and has not been tested for compliance with the limits of computing devices pursuant to part 15 of FCC or ICES-003 rules, which are designed to provide reasonable protection against radio frequency interference. Operation of the equipment may cause interference with radio communications, in which case the user at his own expense will be required to take whatever measures may be required to correct this interference.

General Statement for EVMs including a radio

User Power/Frequency Use Obligations: This radio is intended for development/professional use only in legally allocated frequency and power limits. Any use of radio frequencies and/or power availability of this EVM and its development application(s) must comply with local laws governing radio spectrum allocation and power limits for this evaluation module. It is the user's sole responsibility to only operate this radio in legally acceptable frequency space and within legally mandated power limitations. Any exceptions to this are strictly prohibited and unauthorized by Texas Instruments unless user has obtained appropriate experimental/development licenses from local regulatory authorities, which is responsibility of user including its acceptable authorization.

For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant

Caution

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

For EVMs annotated as IC – INDUSTRY CANADA Compliant

This Class A or B digital apparatus complies with Canadian ICES-003.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

Concerning EVMs including radio transmitters

This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concerning EVMs including detachable antennas

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication.

This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Cet appareil numérique de la classe A ou B est conforme à la norme NMB-003 du Canada.

Les changements ou les modifications pas expressément approuvés par la partie responsable de la conformité ont pu vider l'autorité de l'utilisateur pour actionner l'équipement.

Concernant les EVMs avec appareils radio

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante.

Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

【Important Notice for Users of EVMs for RF Products in Japan】

This development kit is NOT certified as Confirming to Technical Regulations of Radio Law of Japan

If you use this product in Japan, you are required by Radio Law of Japan to follow the instructions below with respect to this product:

1. Use this product in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use this product only after you obtained the license of Test Radio Station as provided in Radio Law of Japan with respect to this product, or
3. Use of this product only after you obtained the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to this product. Also, please do not transfer this product, unless you give the same notice above to the transferee. Please note that if you could not follow the instructions above, you will be subject to penalties of Radio Law of Japan.

Texas Instruments Japan Limited
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<http://www.tij.co.jp>

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本製品のご使用に際しては、電波法遵守のため、以下のいずれかの措置を取っていただく必要がありますのでご注意ください。

1. 電波法施行規則第6条第1項第1号に基づく平成18年3月28日総務省告示第173号で定められた電波暗室等の試験設備でご使用いただく。
2. 実験局の免許を取得後ご使用いただく。
3. 技術基準適合証明を取得後ご使用いただく。

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EVALUATION BOARD/KIT/MODULE (EVM) WARNINGS, RESTRICTIONS AND DISCLAIMERS

For Feasibility Evaluation Only, in Laboratory/Development Environments. Unless otherwise indicated, this EVM is not a finished electrical equipment and not intended for consumer use. It is intended solely for use for preliminary feasibility evaluation in laboratory/development environments by technically qualified electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems and subsystems. It should not be used as all or part of a finished end product.

Your Sole Responsibility and Risk. You acknowledge, represent and agree that:

1. You have unique knowledge concerning Federal, State and local regulatory requirements (including but not limited to Food and Drug Administration regulations, if applicable) which relate to your products and which relate to your use (and/or that of your employees, affiliates, contractors or designees) of the EVM for evaluation, testing and other purposes.
2. You have full and exclusive responsibility to assure the safety and compliance of your products with all such laws and other applicable regulatory requirements, and also to assure the safety of any activities to be conducted by you and/or your employees, affiliates, contractors or designees, using the EVM. Further, you are responsible to assure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard.
3. Since the EVM is not a completed product, it may not meet all applicable regulatory and safety compliance standards (such as UL, CSA, VDE, CE, RoHS and WEEE) which may normally be associated with similar items. You assume full responsibility to determine and/or assure compliance with any such standards and related certifications as may be applicable. You will employ reasonable safeguards to ensure that your use of the EVM will not result in any property damage, injury or death, even if the EVM should fail to perform as described or expected.
4. You will take care of proper disposal and recycling of the EVM's electronic components and packing materials.

Certain Instructions. It is important to operate this EVM within TI's recommended specifications and environmental considerations per the user guidelines. Exceeding the specified EVM ratings (including but not limited to input and output voltage, current, power, and environmental ranges) may cause property damage, personal injury or death. If there are questions concerning these ratings please contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, some circuit components may have case temperatures greater than 60°C as long as the input and output are maintained at a normal ambient operating temperature. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors which can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during normal operation, please be aware that these devices may be very warm to the touch. As with all electronic evaluation tools, only qualified personnel knowledgeable in electronic measurement and diagnostics normally found in development environments should use these EVMs.

Agreement to Defend, Indemnify and Hold Harmless. You agree to defend, indemnify and hold TI, its licensors and their representatives harmless from and against any and all claims, damages, losses, expenses, costs and liabilities (collectively, "Claims") arising out of or in connection with any use of the EVM that is not in accordance with the terms of the agreement. This obligation shall apply whether Claims arise under law of tort or contract or any other legal theory, and even if the EVM fails to perform as described or expected.

Safety-Critical or Life-Critical Applications. If you intend to evaluate the components for possible use in safety critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, such as devices which are classified as FDA Class III or similar classification, then you must specifically notify TI of such intent and enter into a separate Assurance and Indemnity Agreement.

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TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

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In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have **not** been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

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